

L Number	Hits	Search Text	DB	Time stamp
25	38	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene) and thermoplastic) and (semiconductor or printed adj circuit or microelectronic) ("6303219" "5659004" "5523137" "5340851" "5827908").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 13:17
-	13		USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:51
-	2	jp-07268066-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 13:44
-	1	jp-07264595-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 09:30
-	2	jp-08264595-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 13:45
-	2	jp-06279739-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 13:45
-	2	jp-06338681-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 13:46
-	212995	(epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:30
-	629	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:01
-	1035	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 biphenyl	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:48
-	778902	adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:49
-	1337691	semiconductor or printed adj circuit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:49
-	1363689	semiconductor or printed adj circuit or microelectronic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:29
-	7	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 dicylcopentadiene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:50

-	123821	thermoplastic adj resin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/08 14:51
-	369616	thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 09:52
-	369820	thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:29
-	485719	tape	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:29
-	217358	tab	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:29
-	29560	thermoplastic and tape	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:29
-	1364513	semiconductor or printed adj circuit or microelectronic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:30
-	779454	adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:30
-	17986	(thermoplastic and tape) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:30
-	213150	(epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:31
-	631	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:33
-	1036	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 biphenyl	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:31
-	1237	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 dicyclopentadiene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:32
-	306	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 dicyclopentadiene) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:32

-	215	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 biphenyl) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:32
-	193	((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:32
-	104	terpene near5 skeleton	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:33
-	334	biphenyl near5 skeleton	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:33
-	98	dicyclopentadiene near5 skeleton	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:34
-	4	((biphenyl near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:35
-	4	((dicyclopentadiene near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:35
-	4	((terpene near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)) and thermoplastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:35
-	4	(dicyclopentadiene near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:36
-	7	(biphenyl near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:36
-	22	(terpene near5 skeleton) and ((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 10:38
-	140	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 biphenyl) and thermoplastic) and (semiconductor or printed adj circuit or microelectronic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:21
-	38	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene) and thermoplastic) and (semiconductor or printed adj circuit or microelectronic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 13:16
-	72	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 dicyclopentadiene) and thermoplastic) and (semiconductor or printed adj circuit or microelectronic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:20

-	6172	tape adj automated adj bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:21
-	7	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 dicyclopentadiene) and thermoplastic) and (tape adj automated adj bonding)	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:21
-	2	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 terpene) and thermoplastic) and (tape adj automated adj bonding)	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:21
-	4	((((epox?\$3 near (resin\$ or novola?)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$) near10 biphenyl) and thermoplastic) and (tape adj automated adj bonding)	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/09 11:22